A CONTROL OF TOXIC PERFLUORINATED COMPOUND BY ELECTRON-BEAM TECHNOLOGY

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Introduction

Nitrogen trifluoride (NF₃) is used as a novel etching and cleaning gas in semiconductor industry. And it has a global warming potential (GWP) of 18,000 times relative to CO_2 and atmospheric lifetime of 740 years. In addition, it is very toxic (threshold limit value of 10 ppm) and chemically reactive. [1-2]. Therefore it is strongly required to destruct the NF₃ gas from industrial processes because of more and more emission of NF₃ gas into atmosphere. The purpose of this study is introduction of decomposition of the nitrogen trifluoride (NF₃) by Electron-Beam (EB) irradiation and additive gases (e.g., hydrogen (H₂) and oxygen (O₂)).

The machanism of NF_3 gas dissociation is shown below in Figure 1.



Figure 1. The mechanism of toxic NF₃ gas ³⁾

Materials and methods

The experiments were conducted in a continuous type pilot scale, with a capacity of $3m^3/hr$ with NF₃ of 1000 ppm. The electron beam was generated with an ELV-4 type (EB-Tech Co, LTD, Korea) with an 1 MeV, a 40 mA current, and 40 kW power of a commercial scale accelerator. The applied dose (irradiated energy to NF₃ gas, 1 kGy = 1 kJ/kg) was varied from 0 to 400 kGy. The analytical techniques used for this study included GC (Gas Chromatography, 7890N, Agilent Technology) and FTIR (MIDAC i4001). Experimental conditions and setup are shown in Table 1 and Figure 2, respectively.

Table 1.	Experimental	conditions.
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Contents	Experimental conditions
Dose (kGy)	50, 100, 200, 300, 400
Current (mA)	2, 5, 10, 15, 20
NF₃ Conc.	N₂: 50L/min NF₃: 1000ppm (50ml/min)
Additive gas(ppm) H _{2,} O _{2,} H ₂ O	500, 1000, 1500, 2000, 2500, 3000
Reactor specifications	Flux : 50L/min capacity: 110*690*202mm (15.3L) Residence time : 18.4sec Reactor temperature : 0~400℃
Irradiation time-Batch (sec)	3, 5, 10, 15, 20



Figure 2. Experimental Setup

Results and discussion: *DRE of NF*₃ gas with dose only

The average DRE(%) of NF₃ gas over the dose range of 50-400 kGy at a flow rate of 50L/min with 1,000 ppm NF3 gas is presented in Figure 3. The average DRE(%) values are obtained from replicated experiments. As dose increased DRE(%) of NF₃ gas were also increased and observed to peak at a dose of 400 kGy. At this time, DRE(%) of NF₃ gas was about 90%.



Figure 3. NF₃ DRE(%) with dose only

DRE of NF_3 gas with dose and additive gases

Figure 4 shows the average DRE(%) of NF₃ gas with electron-beam current over H₂ additive gas injection. Injected H₂ gas concentration were 0, 500, 1,000, 1,500, 2,000, 2,500, and 3,000 ppm. Electron-beam current were 5mA, 10mA, and 15mA, respectively. At 5mA with no additive gas, DRE(%) of NF₃ gas was about 54%. At 10mA and 15mA, with no additive gas, DRE(%) of NF₃ gas were about 58% and 65%, respectively. However, DRE(%) of NF₃ gas were about 50%, 60% and 76% at 5, 10, 15mA of electron-beam current , respectively when H₂ additive gas of 500ppm is injected. DRE(%) of NF₃ gas were about 70%, 94% and 98% at 5, 10, 15mA of electron-beam current , respectively when H₂ additive gas injection increased drastically DRE(%) of NF₃ gas.



Figure 4. NF₃ DRE(%) with dose and additive gases.

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